



| No | DESCRIPTION |
|------|-------------------|
| (1) | SUBSTRATE |
| (2) | HEAT SINK |
| (3) | FPC |
| (4) | COMMON LEAD FRAME |
| (5) | CONNECTOR |
| (6) | CAPACITOR |
| (7) | CHIP CAPACITOR |
| (8) | CHIP THERMISTOR |
| (9) | ADHESIVE 1 |
| (10) | ADHESIVE 2 |
| (11) | ADHESIVE TAPE 1 |
| (12) | ADHESIVE TAPE 2 |
| (13) | LABEL |



TITLE
KEE-57-12GAN1-STA
OUTLINE DWG